GBU60X SERIES

GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER

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GBU6005 THRU GBU610

GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 6.0 AMPERE

FEATURES

· Glass passivated chip junction

· Reliable low cost construction utilizing molded plastic technique

· Ideal for printed circuit board

· Low forward voltage drop

· Low reverse leakage current

· High surge current capability

MECHANICAL DATA

Case: Molded plastic, GBU

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.15ounce, 4.0gram Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at $25\,^{\circ}$ C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	GBU6005	GBU601	GBU602	GBU604	GBU606	GBU608	GBU610	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward $T_C=100^{\circ}$ Rectified Current at (Note 1),(Note 2)	I _(AV)	6.0							Amp
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	175							Amp
Maximum Forward Voltage at 6.0A DC and 25℃	$\mathbf{V_F}$	1.0							Volts
Maximum Reverse Current at $T_A=25^{\circ}$ C at Rated DC Blocking Voltage $T_A=125^{\circ}$ C	I_R	5.0 500						uAmp	
Typical Junction Capacitance (Note 3)	C_{J}	210 94					pF		
Typical Thermal Resistance (Note 1),(Note 2)	$R_{\theta JA}$	7.4						°C/W	
Typical Thermal Resistance (Note 1),(Note 2)	$R_{\theta JC}$	2.2						°C/W	
Operating and Storage Temperature Range	T _J , Tstg	-55 to +150							Ç

NOTES:

- 1- Units case mounted on 2.6 x 1.4 x 0.06" thick (6.5 x 3.5 x 0.15 cm) Al. Plate heatsink
- 2- Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screws
- 3- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.



RATINGS AND CHARACTERISTIC CURVES

Fig. 1 – Derating Curve
Output Rectified Current

6.0

Heatsink Mounting,
2.6 x 1.4 x 0.06" Thk
(6.5 x 3.5 x .15cm) AL. Plate

4.0

4.0

60 Hz Resistive or Inductive Load
0 50

Case Temperature (°C)

Fig. 2 – Maximum Non-Repetitive Peak
Forward Surge Current Per Leg

Single Sine-Wave (JEDEC Method)

T_J = 150°C

T_J = 150°C

Number of Cycles at 60 H_Z

Fig. 3 – Typical Forward Characteristics Per Leg





